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| # | Location | Reaction |
| 1 |  | Solved |
| 2 |  | Solved |
| 3 |  | It seems there is a round off error.  The PCB is designed in mil unit and the width of the trace is 9.842 mil. When turned into mm it is equal to 0.2499868 which is less than 0.25.  **Does it impact the fabrication?** |
| 4 |  | It seems there is a round off error.  The PCB is designed in mil unit and the width of the trace is 9.842 mil. When turned into mm it is equal to 0.2499868 which is less than 0.25.  **Does it impact the fabrication?** |
| 5 |  | The trace is re-routed.  **Are there any problems?** |
| 6 |  | The trace is re-routed.  **Are there any problems?** |
| 7 |  | Solved |
| 8 |  | This is standard device footprint.  **Is there any problem in fabrication?** |
| 9 |  | Both cooper and plated circle are not connected to anywhere. They are designed to fortify the socket position with no connection.  **Does it make any impact on the fabrication?** |
| 10 |  | The trace is re-routed.  Please check. |
| 11 |  | The trace is re-routed.  Please check. |
| 12 |  | Via were replaced.  Please check |
| 13 |  | Trace width changed.  Please check. |
| 14 |  | Trace width changed.  Please check. |
| 15 |  | Trace width changed.  Please check. |
| 16 |  | The distance increased |
| 17 |  | Traces are re-routed |
| 18 |  | Via are relocated |
| 19 |  | solved |
| 20 |  | This is standard foot print.  **Does it make a problem in fabrication?** |
| 21 |  | Solved |
| 22 |  | Solved |